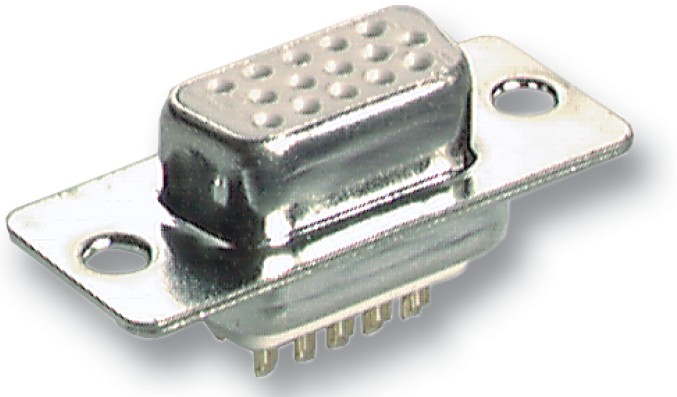
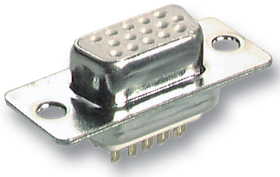
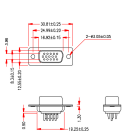
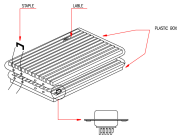
DATASHEET

HD-DSub Solder Jack E-HDF 15 LL/Z









General data

- Tin-plated housing
- Quality level III >= 50 mating cycles

Tekniske egenskaber

Available variants

ArtNr.	Bezeichnung	Number of poles
34501.1	HD-DSub Solder Jack E-HDF 15 LL/Z	15
34510.1	HD-DSub Solder Jack E-HDF 26 LL/Z	26

Note on Intended Use

This data sheet is intended solely to describe the technical characteristics of the product. It does not replace an assessment of the product's suitability for a specific application. The user is responsible for ensuring that the product is used in accordance with its technical specifications and applicable legal and regulatory requirements.

This datasheet was created automatically on 05-11-2026 . Technical changes reserved.

EFB-Elektronik GmbH
Striegauer Straße 1
33719 Bielefeld

fon: +49 521 40 41 8-0
fax: +49 521 40 41 8-50

info@efb-elektronik.de
www.efb-elektronik.de

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